



## Application brief

# Smart speaker

## Design speakers for an intuitive and outstanding user experience

Once a novelty in households, smart speakers are more and more becoming increasingly commonplace. This rapid adoption is accompanied by rising user expectations. Frustration with devices that do not understand or hear commands is, however, leading to lower user adoption.

Consequently, growth rates for smart speakers are failing to reach their full potential. Components such as MEMS microphones, touch controllers and new technologies such as radar are key to improving the user experience in the smart speaker segment.

Infineon has long-standing expertise in sensor, connectivity and power solutions that fulfill the consumer market requirements in terms of outstanding performance, reliability and energy efficiency.

## Choose Infineon to solve your application requirements for smart speakers



Best-in-class voice recognition

› Highly sensitive XENSIV™ MEMS microphones to pick up whispered or far-field voice commands
 › Low self-noise (SNR), wide dynamic range, low distortions, high acoustic overload point



Outstanding audio performance

- → MERUS™ Class D amplifiers solutions provide best-in-class audio quality and have lowest power consumption for extended battery playback time
- > Less filtering/external components required due to its multi-level design, leading to less heat and overall BOM savings



Connectivity for highest interoperability and performance

- >> AIROC™ Wi-Fi and combos portfolio integrates Wi-Fi and Bluetooth® in a single-chip solution to enable small-form-factor IoT designs
- > Ultralow power Wi-Fi designed for battery operations, whole home range with high throughput ensures clear audio streaming without audio dropouts anywhere in the home



Reliable touch interaction and gesturing

- > State-of-the-art noise immunity capacitive touch and gesture detection for a reliable and durable speaker HMI
- > Advanced inductive touch sensors make possible sleek, futuristic user interfaces with metallic overlays



Advanced radar sensing

- > XENSIV™ 60GHz radar sensor solutions bring innovative, intuitive sensing capabilities
- > Presence detection, segmentation, people tracking, vital sensing



Secured cloud service provisioning

- > Easy and secure provisioning services with OPTIGA™ Trust M for maintaining speaker's unique identity and integrity
- > Unify different products under unified PKI architecture



Disruptive CO<sub>2</sub> sensor based on photoacoustic spectroscopy (PAS)

- >> XENSIV™ PAS CO2 sensor track the environment for improved health, productivity, and overall well-being
   >> Real-time CO₂ monitoring for demand-controlled ventilation systems, air purifiers,
- and thermostats while allowing users to accurately measure and adjust indoor air quality
- > High performance in small size



**Power portfolio** for energy-efficient, space saving designs

- > Wireless charging solutions for maximum performance, efficiency and safety
- > USB-C PD solutions for standardized power adapters
- > Extensive SMPS power portfolio for energy-efficient, space saving design
- > ESD devices for capable protection solutions with outstanding clamping

## Bring your smart speaker to the next level with Infineon's recommended product portfolio

| Functional block | Product family                           |                        | Product  | Benefits  |
|------------------|--|------------------------|--|---|
|                  |  |                        |  |   |
| Audio input      | Microphones                              |                        | XENSIV™ MEMS<br>microphones  | > High performance microphone with low self-noise (high SNR) and low distortions, setting a new performance benchmark for a superior user experience  |
| Audio output     | Class D<br>amplifier                     |                        | MERUS™ class D audio<br>amplifiers MA120xx                         | Cooler, smaller and lighter amplifiers designed to maximize power efficiency and dynamic range while providing best-in-class audio performance in product form factors for great sounding audio products     Extended battery playback time or the reduction of battery size without compromising on battery playback time to save cost |
| Connectivity     | Wi-Fi +<br>Bluetooth®<br>combos          |                        | AIROC™ Wi-Fi +<br>Bluetooth combos                                 | Best-in-class interoperability to the widest deployed wireless IP     Whole Home Range with high throughput for multi-channel audio and RSDB     (Real Simultaneous Dual Band) for speaker sub-networks     Ultralow power technology designed with battery operation in mind   |
|                  | Capacitive sensing touch controller      |                        | CAPSENSE™<br>Controllers<br>capacitive touch<br>sensing controller | <ul> <li>&gt; State-of-the-art noise immunity (SNR &gt; 100:1) and water rejection have made<br/>CAPSENSE™ Controllers the industry leader</li> <li>&gt; Advanced inductive touch sensors make possible sleek, futuristic user interfaces<br/>with metallic overlay</li> </ul>  |
| Sensing          | Radar sensor                             |                        | XENSIV™ 60 GHz<br>radar sensor                                     | <ul> <li>Accurate presence detection and vibration detection based on ability to track<br/>sub-millimeter motion at high speed and accuracy</li> <li>Both stand-alone chip as well as system solution available</li> </ul>  |
|                  | CO <sub>2</sub> sensor                   |                        | XENSIV™ PAS CO2<br>sensor  | > Superior accuracy, providing a direct readout of the real ${\rm CO_2}$ level, not simply a correlation > Size and cost advantages   |
| Security         | IoT security<br>controller               |                        | OPTIGA™ Trust M  | <ul> <li>&gt; Easy and secure provisioning services with OPTIGA™ Trust M for maintaining<br/>speaker's unique identity and integrity</li> <li>&gt; Unify different products under unified PKI architecture</li> </ul>   |
| Power            | USB-C PD controller                      |                        | EZ-PD™ USB-C<br>controller   | <ul> <li>USB-IF certified with market-proven USB PD stack, ensuring spec compliance and interoperability</li> <li>Supports all USB PD profiles commonly used in USB-C power adapters and requires no firmware development</li> <li>A highly-integrated solution that minimizes incremental BOM costs</li> </ul>                         |
|                  | ESD protection                           |                        | ESD111, ESD245   | <ul><li>Outstanding low capacitance devices for best signal integrity</li><li>High protection performance by ultralow clamping voltage</li></ul>  |
|                  | Wireless charging                        |                        | 15 W inductive wireless power transmitter                          | > Powerful and cost-effective wireless charging solutions for high performance, smart and<br>secure charging solutions supported by Infineon's unique wireless power controllers  |
|                  | High-voltage<br>MOSFETs                  | Flyback                | 700 V CoolMOS™ P7<br>(standard grade)                              | <ul> <li>&gt; Best price-competitive CoolMOS™ SJ MOSFET family</li> <li>&gt; Lower switching losses than a standard MOSFET</li> </ul>   |
|                  |  | ACF, FMCI              | 600 V CoolMOS™ PFD7  | > Lower Q <sub>rr</sub> , lower hysteresis loss, low R <sub>DS(on)</sub>  |
|                  | SMPS flyback<br>converter<br>Control ICs | QR flyback ICs         | ICE5QSAG   | > High efficiency and low standby power   |
|                  |  | FFR flyback IC         | XDPS21071  | > High power density and ideal for USB-PD   |
|                  | SMPS                                     | Low-voltage<br>MOSFETs | OptiMOS™ PD  | <ul> <li>Low conduction losses and reduced overshoot</li> <li>Logic level switching / S308 / PQFN 3.3x3.3 packages available</li> </ul>   |
|                  | synchronous<br>rectification             | Control ICs            | IR1161LTRPBF   | <ul><li>&gt; High efficiency</li><li>&gt; Simple external circuitry</li></ul>   |
|                  | SMPS load<br>switch                      | Low voltage<br>MOSFETs | OptiMOS™ 30 V  | > Low conduction losses > S308 / PQFN 3.3x3.3 packages available  |

Published by Infineon Technologies AG 81726 Munich, Germany

© 2022 Infineon Technologies AG. All Rights Reserved.

#### Please note

This Document is for information purposes only and any information given herein shall in no event be regarded as a warranty, guarantee or description of any functionality, conditions and/or quality of our products or any suitability for a particular purpose. With regard to the technical specifications of our products, we kindly ask you to refer to the relevant product data sheets provided by us. Our customers and their technical departments are required to evaluate the suitability of our products for the intended application.

We reserve the right to change this document and/or the information given herein at any time.

#### Additional information

For further information on technologies, our products, the application of our products, delivery terms and conditions and/or prices, please contact your nearest Infineon Technologies office (www.infineon.com).

### Warnings

Due to technical requirements, our products may contain dangerous substances. For information on the types in question, please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by us in a written document signed by authorized representatives of Infineon Technologies, our products may not be used in any life-endangering applications, including but not limited to medical, nuclear, military, life-critical or any other applications where a failure of the product or any consequences of the use thereof can result in personal injury.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

EVALSENSMARTALARMTOBO2